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1 Characteristics

Symbol	Parameter			Value		Unit	
Symbol	Falamete	1		MSS40 MSS50			
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage			1200	800 1200	V	
I _{T(RMS)}	RMS on-state current $\frac{T_{c} = 80^{\circ} C}{T_{c} = 85^{\circ} C}$			55		A	
			$T_c = 85^\circ C$		70		
I _{TSM}	Non repetitive surge peak on-state current	t _p = 16.7 ms	– T _j = 25° C	420	630		
		t _p = 20 ms		400	600	Α	
l ² t	I ² t Value for fusing	t _p = 10 ms	T _j = 25° C	800	1800	A ² s	
dl/dt	Critical rate of rise of on-state current $I_G = 2 \ x \ I_{GT}$, $t_r \le 100 \ ns$	F = 120 Hz	$T_j = 125^\circ C$	50		A/µs	
I _{GM}	Peak gate current $t_p = 20 \ \mu s$ $T_j = 125^{\circ} \ C$		4	4	A		
P _{G(AV)}	Average gate power dissipation $T_j = 125^{\circ} C$			1		W	
T _{stg} T _i	Storage junction temperature range Operating junction temperature range				+ 150 + 125	°C	
V _{RGM}	Maximum peak reverse gate voltage				5		

Table 3. Absolute ratings (limiting values)

Table 4.	Electrical characteristics (T _i = 25° C, unless otherwise specified)
Table 4.	Electrical characteristics $(I_j = 25^{\circ} \text{ C}, \text{ unless otherwise specified})$

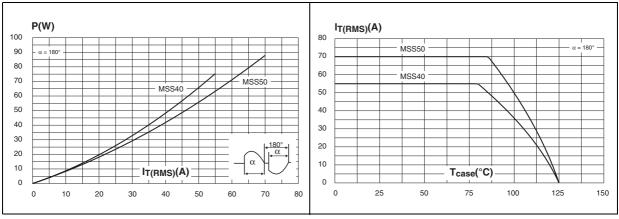
Symbol	Test Conditions			Value		Unit
Symbol				MSS40	MSS50	Onit
		CV.	MIN.	Ę	5	mA
I _{GT}	$V_D = 12 V$ $R_L = 33 \Omega$		MAX.	5	0	ША
V _{GT}	V _{GT}			1.3		V
V _{GD}	$V_D = V_{DRM}$ $R_L = 3.3 k\Omega$	$T_j = 125^\circ C$	MIN.	0.	2	V
Ι _Η	I _T = 500 mA Gate open	MAX.	80		mA	
١L	I _G = 1.2 I _{GT}	MAX.	120		mA	
dV/dt	V _D = 67 % V _{DRM} Gate open	MIN.	1000		V/µs	
V _{TM}	$I_{TM} = 80 \text{ A} t_p = 380 \ \mu \text{s}$		MAX.	1.7		V
V TM	I _{TM} = 100 A t _p = 380 μs	$T_j = 25^\circ C$	IVIAA.		1.7	v
V _{t0}	Threshold voltage $T_j = 125^{\circ} C$		MAX.	0.85		V
R _d	Dynamic resistance	$T_j = 125^\circ C$	MAX.	11	7	mΩ
IDRM	$T_j = 25^\circ C$		MAX.	20		μA
I _{RRM}	$V_{DRM} = V_{RRM}$	T _j = 125° C		10		mA

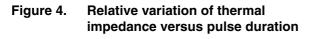
Table 5.Thermal reistances

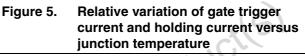
Symbol	Parameter			Unit	
R _{th(j-c)}	lunction to cope (AC)	MSS40	0.6 ° C/W		
	Junction to case (AC)	MSS50	0.45	C/W	

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Figure 2. Maximum average power Figure 3. dissipation versus average on-state current







Average and DC on-state current

versus case temperature

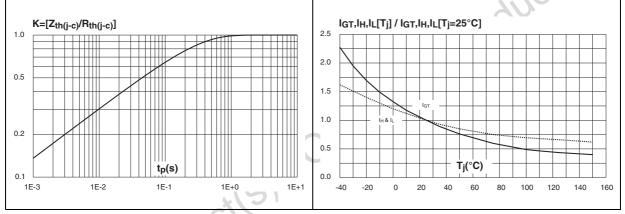
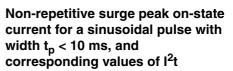
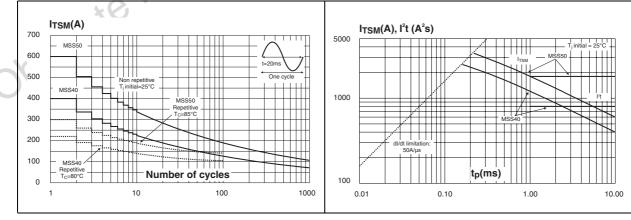


Figure 6. Surge peak on-state current versus Figure 7. number of cycles

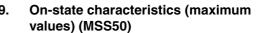


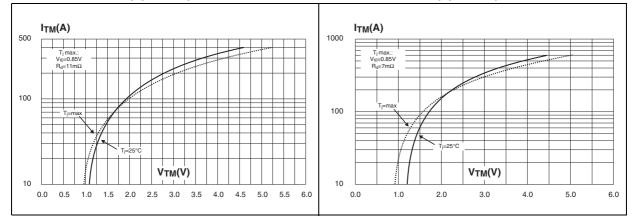


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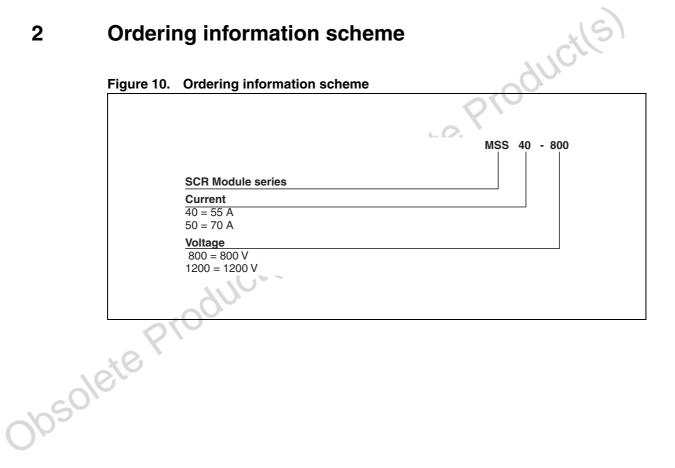
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On-state characteristics (maximum Figure 9. Figure 8. values) (MSS40)





Ordering information scheme 2



3 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.9 Nm (max. 1.2 Nm) for the 6 x M4 screws (2 x M4 screws recommended for mounting the package on the heatsink and the 4 provided screws).
- The screws supplied with the package are adapted for mounting on a board (or other types of terminals) with a thickness of 0.6 mm min. and 2.2 mm max.

Dimensions Millimeters Ref. Inches Min. Max. Min. Max. 11.80 12.20 0.465 0.480 А G2 С 8.90 9.10 0.350 A1 0.358 В 7.8 8.20 0.307 0.323 Δ A С 0.85 0.75 0.030 0.033 C2 E2 C2 1.95 2.05 0.077 0.081 D 37.80 38.20 1.488 1.504 D1 31.50 31.70 1.240 1.248 Е 25.15 25.50 0.990 1.004 24.15 0.939 0.951 E1 23.85 G D1 E2 24.80 typ. 0.976 typ. S D G 14.90 15.10 0.587 0.594 в G1 12.60 12.80 0.496 0.504 G2 3.50 4.30 0.138 0.169 F 4.10 4.30 0.161 0.169 ØP Josolete G1 5.00 F1 4.60 0.181 0.197 E1 Р 4.00 4.30 0.157 0.69 P1 4.00 4.40 0.157 0.173 S 30.10 30.30 1.185 1.193

Table 6. ISOTOP dimensions

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



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4 Ordering information

Table 7.Ordering information

Part number	Marking	Package	Weight	Base qty	Delivery mode
MSS40-1200	MSS40-1200		07	10	
MSS50-800	MSS50-800	ISOTOP	27 g (without screws)	10 (with screws)	Tube
MSS50-1200	MSS50-1200		(minourconomo)	(mar corono)	

5 Revision history

Table 8. Revision history

	Date	Revision	Changes
	Sep-2000	3	Last release.
	11-Jul-2007	4	Reformated to current standards. Removed MSS40-800 product.
obsole	tepro	ductl	obsolete Pro-

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